



### **DUAL N-CHANNEL ENHANCEMENT MODE MOSFET**

## **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> Max	I <sub>D</sub> Max T <sub>A</sub> = +25°C
201/	20mΩ @ V <sub>GS</sub> = 10V	7.7A
30V	32mΩ @ V <sub>GS</sub> = 4.5V	6.1A

# **Description and Applications**

This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP, and is ideal for use in:

- General Purpose Interfacing Switch
- Power Management Functions

## **Features and Benefits**

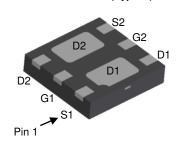
- 0.6mm Profile Ideal for Low Profile Applications
- Low Gate Threshold Voltage
- Low On-Resistance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMT3020LFDBQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

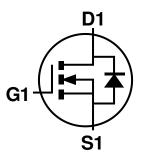
### **Mechanical Data**

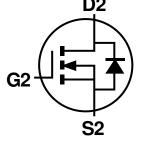
- Case: U-DFN2020-6
- Case Material: Molded Plastic, "Green" Molding Compound.
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu Annealed over Copper Leadframe.
   Solderable per MIL-STD-202, Method 208 @
- Terminals Connections: See Diagram Below
- Weight: 0.0065 grams (Approximate)

### U-DFN2020-6 (Type B)



**Bottom View** 





Internal Schematic

## Ordering Information (Note 4)

Part Number	Case	Packaging
DMT3020LFDBQ-7	U-DFN2020-6 (Type B)	3,000/Tape & Reel
DMT3020LFDBQ-13	U-DFN2020-6 (Type B)	10,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



# **Marking Information**

Site 1:

### U-DFN2020-6 (Type B)



Y2 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: H = 2020) M = Month (ex: 9 = September)

Date Code Key

Year	2020	2021	2022	2023	2024	2025	2026	2027	2028	2029	2030	2031
Code	Н		J	K	L	М	N	0	Р	R	S	Т
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec

Site 2:

### U-DFN2020-6 (Type B)



Y2 = Product Type Marking Code YWX = Date Code Marking

Y = Year (ex: 0 = 2020)
W = Week (ex: a = week 27; z Represents Week 52 and 53)
X = Internal Code (ex: U = Monday)

Date Code Kev

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Ī	Year	2020	2021	2022	2023	2024	2025	2026	2027	2028	2029	2030	2031
Ī	Code	0	1	2	3	4	5	6	7	8	9	0	1

	Week	1-26	27-52	53
Г	Code	A-Z	a-z	Z

Internal Code	Sun	Mon	Tue	Wed	Thu	Fri	Sat
Code	T	U	V	W	Χ	Υ	Z



# **Maximum Ratings** (@ $T_A = +25^{\circ}C$ , unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Drain-Source Voltage			$V_{DSS}$	30	V
Gate-Source Voltage		V <sub>GSS</sub>	±20	V	
Continuous Drain Current (Note 6) V <sub>GS</sub> = 10V	Steady State	T <sub>A</sub> = +25°C T <sub>A</sub> = +75°C	I <sub>D</sub>	7.7 6.2	Α
Maximum Continuous Body Diode Forward Current	(Note 6)	ls	2	Α	
Pulsed Drain Current (380µs Pulse, Duty Cycle = 1	%)		I <sub>DM</sub>	50	Α

## **Thermal Characteristics**

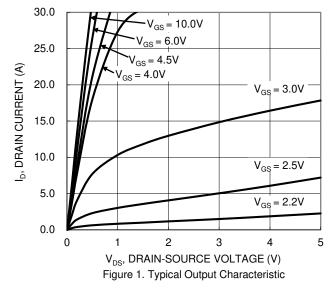
Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)		PD	0.7	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	$R_{\theta JA}$	170	°C/W
Total Power Dissipation (Note 6)		PD	1.8	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	$R_{\theta JA}$	70	°C/W
Operating and Storage Temperature Range		T <sub>J,</sub> T <sub>STG</sub>	-55 to +150	°C

# **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	30	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$
Zero Gate Voltage Drain Current $T_J = +25^{\circ}C$	l <sub>DSS</sub>	_	_	1	μΑ	$V_{DS} = 24V, V_{GS} = 0V$
Gate-Source Leakage	Igss	_	_	±100	nA	$V_{GS} = \pm 20V$ , $V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V <sub>GS(TH)</sub>	1.0	_	2.5	V	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$
Static Drain-Source On-Resistance	Descent			20	mΩ	$V_{GS} = 10V, I_D = 9.0A$
Static Dialif-Source Off-Nesistance	RDS(ON)	_		32	11122	$V_{GS} = 4.5V, I_D = 7.0A$
Diode Forward Voltage	V <sub>SD</sub>	_	_	1.0	V	$V_{GS} = 0V$ , $I_{S} = 2A$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	Ciss	_	393	_	pF	15)/ )/ 0)/
Output Capacitance	Coss	_	173	_	pF	V <sub>DS</sub> = 15V, V <sub>GS</sub> = 0V, -f = 1.0MHz
Reverse Transfer Capacitance	C <sub>rss</sub>	_	27	_	рF	1 – 1.000112
Gate Resistance	Rg	_	1.1	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$
Total Gate Charge (V <sub>GS</sub> = 10V)	Qg	_	7.0	_	nC	
Total Gate Charge (VGS = 4.5V)	Qg	_	3.6	_	nC	\/ 15\/ I- 0A
Gate-Source Charge	Qgs	_	0.9	_	nC	$V_{DD} = 15V$ , $I_D = 9A$
Gate-Drain Charge	Qgd	_	1.5	_	nC	
Turn-On Delay Time	tD(ON)	_	1.8	_	ns	
Turn-On Rise Time	t <sub>R</sub>	_	1.9	_	ns	$V_{DD} = 15V, V_{GS} = 10V,$
Turn-Off Delay Time	tD(OFF)	_	7.5	_	ns	$R_G = 6\Omega$ , $I_D = 9A$
Turn-Off Fall Time	tF	_	2.4	_	ns	1
Reverse Recovery Time	t <sub>RR</sub>	_	10	_	ns	L 0.0 dl/db d0.00/cc
Reverse Recovery Charge	Qrr	_	2.6	_	nC	I <sub>F</sub> = 9A, di/dt = 100A/μs

- Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
   Device mounted on FR-4 substrate PC board, 2oz copper, with 1-inch square copper plate.
   Short duration pulse test used to minimize self-heating effect.
   Guaranteed by design. Not subject to product testing.





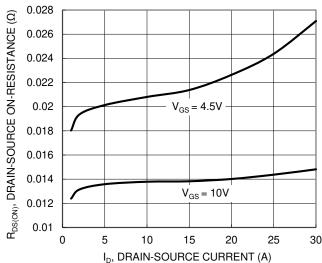


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

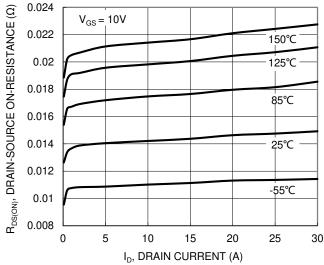
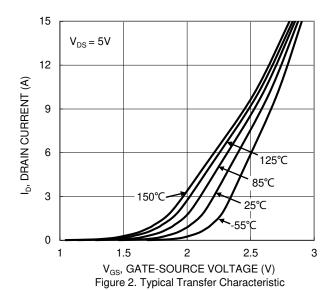
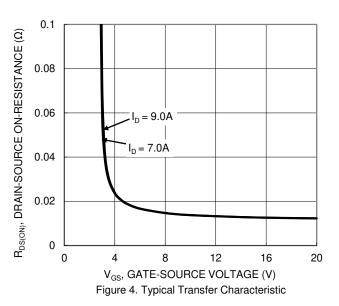


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature





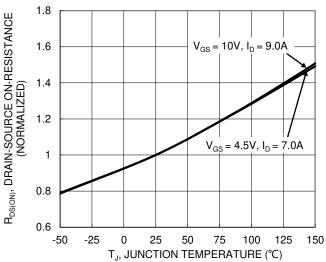


Figure 6. On-Resistance Variation with Junction Temperature



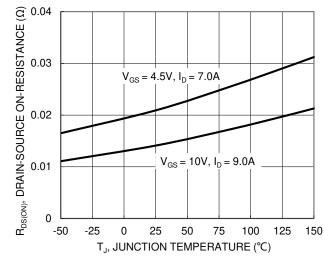


Figure 7. On-Resistance Variation with Junction Temperature

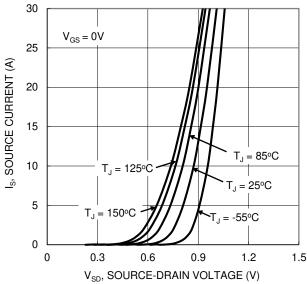


Figure 9. Diode Forward Voltage vs. Current

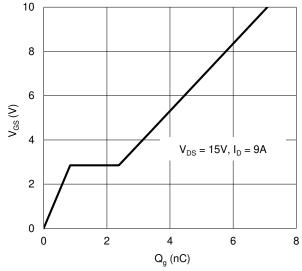


Figure 11. Gate Charge

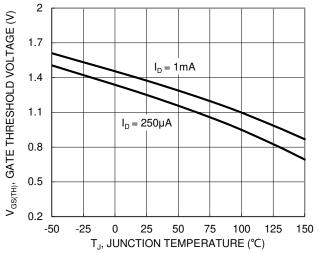


Figure 8. Gate Threshold Variation vs. Junction Temperature

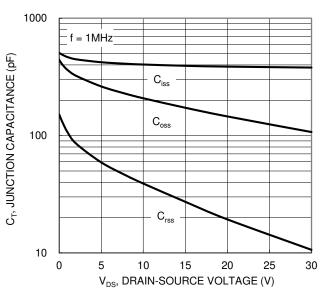


Figure 10. Typical Junction Capacitance

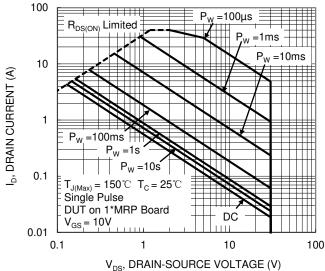


Figure 12. SOA, Safe Operation Area



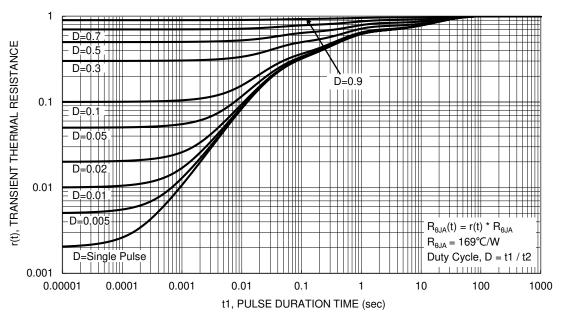


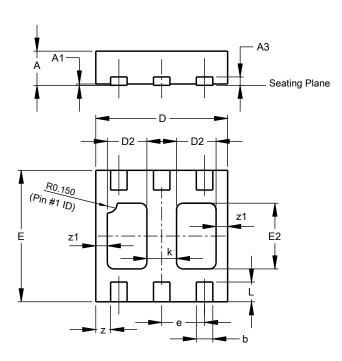
Figure 13. Transient Thermal Resistance



# **Package Outline Dimensions**

 $Please see \ http://www.diodes.com/package-outlines.html \ for \ the \ latest \ version.$ 

### U-DFN2020-6 (Type B)

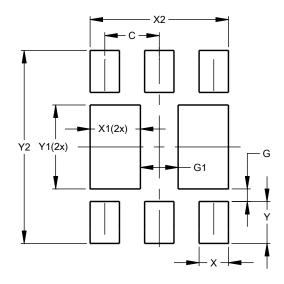


U-DFN2020-6 Type B						
Dim	Min	Max	Тур			
Α	0.545	0.605	0.575			
<b>A</b> 1	0.00	0.05	0.02			
A3	-	-	0.13			
b	0.20	0.30	0.25			
D	1.95	2.075	2.00			
D2	0.50	0.70	0.60			
е	-	-	0.65			
Е	1.95	2.075	2.00			
E2	0.90	1.10	1.00			
k	-	-	0.45			
L	0.25	0.35	0.30			
Z	-	-	0.225			
z1	-	-	0.175			
All	Dimens	ions in	mm			

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

## U-DFN2020-6 (Type B)



Dimensions	Value		
Difficusions	(in mm)		
С	0.650		
G	0.150		
G1	0.450		
Х	0.350		
X1	0.600		
X2	1.650		
Υ	0.500		
Y1	1.000		
Y2	2.300		



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